

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Yoshihiro TAKAHASHI et al.

Serial No.: 09/985,898

Filed: November 6, 2001

For: SURFACE ACOUSTIC WAVE FILTER AND SURFACE ACOUSTIC WAVE FILTER APPARATUS

Honorable Commissioner of Patents
Washington, D.C. 20231



Group Art Unit: 2834

Examiner: Jaydi A. Aguirrechea

EXCESS CLAIM FEE PAYMENT LETTER

Sir:

Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.

	<u>AFTER AMENDMENT</u>	<u>PREV. PAID FOR</u>	<u>EXTRA CLAIMS PRESENT</u>	<u>RATE</u>	<u>FEE DUE</u>
Total Claims	21 -	20	= 1	x \$18.00	\$ 18.00
Indep. Claims	6 -	3	= 3	x \$84.00	\$ 252.00

TOTAL ADDITIONAL FEE FOR THIS AMENDMENT

\$ 270.00

A check in the amount of \$270.00 to cover the excess claim fees is attached hereto. A duplicate copy of this sheet is enclosed. The Commissioner is authorized to charge any deficiencies in fees and credit any overpayment of fees to Attorney's Deposit Account No. 50-0481.

Respectfully Submitted,

Date: 2/28/03

Kendal M. Sheets

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Issue Application of

Yoshihiro TAKAHASHI et al.

Serial No.: 09/985,898

Group Art Unit: 2834

Filed: November 6, 2001

Examiner: Jaydi A. Aguirrechea

For: SURFACE ACOUSTIC WAVE FILTER AND SURFACE ACOUSTIC WAVE
FILTER APPARATUS

Honorable Commissioner of Patents
Washington, D.C. 20231

AMENDMENT UNDER 37 C.F.R. §1.111

Sir:

In response to the Office Action dated November 29, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claims 3 and 6 without prejudice or disclaimer.

Please amend claim 9 to read as follows:

9. (Amended) A surface acoustic wave filter, comprising:

a plurality of pairs of comb electrode patterns formed on an upper surface of a chip substrate made of a piezoelectric material, wherein opposing portions of two comb electrode patterns that form a pair are not sharp, and

wherein the filter is accommodated in a plastic package.

03/04/2003 CCHAU1 00000029 09985898

01 FC:1201
02 FC:1202

252.00 DP
18.00 DP